

Supplementary materials to article:

“Comparative studies of the properties of copper components: conventional vs additive manufacturing technologies”

by Witold Malec, et al.

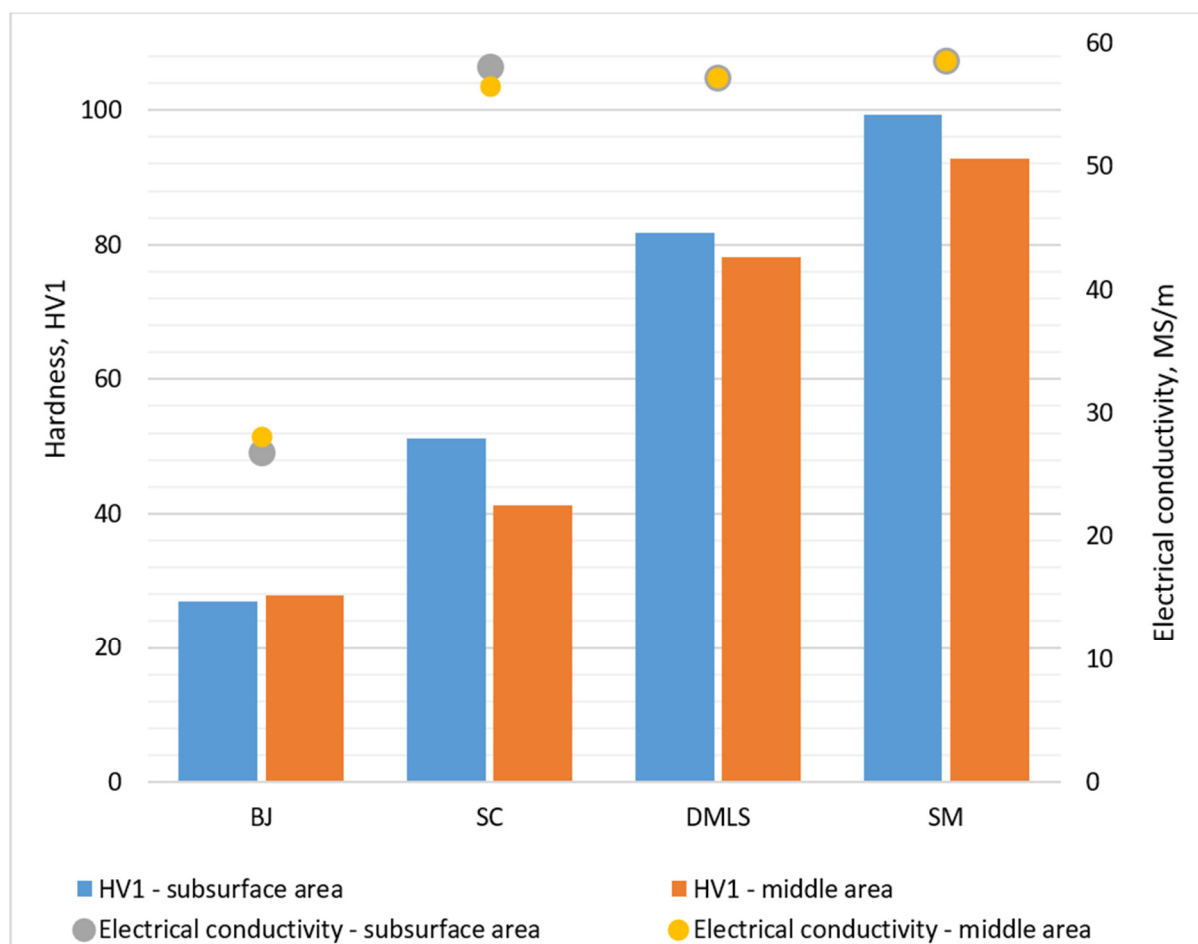


Figure S1. Graphical representation of hardness and electrical conductivity results shown in Table 2. Data obtained for subsurface and middle area are separately presented.